

The High-Speed Ultraminiature Connector for Harsh Environments



Specifications

| SuperFly Datalink Standard Materials | | | |
|--------------------------------------|-----------------------------------|---|--|
| DESCRIPTION | MATERIAL | FINISH | |
| Contacts | Copper alloy | Gold 50 microinches minimum over nickel | |
| Shell, coupling nut, backshell | Aluminum alloy or stainless steel | Code M: Electroless nickel per ASTM B-733 Code MT: Nickel-PTFE per SAE AMS2454 Code ZR: Black zinc-nickel per ASTM B841 Code Z2: Gold per MIL-G-45204 Code ZMT: Nickel-PTFE per SAE AMS2454 over SST material | |
| Insulators, PCB tray | High-grade rigid dielectric | None | |
| Grommet | Fluorosilicone blend elastomer | None | |
| O-rings | Fluorosilicone blend elastomer | None | |
| Latching EMI spring | Stainless steel | Gold | |
| Shield sleeve, ferrule | Copper alloy | Electroless nickel | |
| Spline, SuperFly Datalink White | Copper alloy | Electroless nickel | |
| Potting compound for 90° PCB | Ероху | | |

| SuperFly Datalink Performance Specifications | | | | |
|--|---|--|--|--|
| DESCRIPTION | REQUIREMENT | PROCEDURE | | |
| Operating temperature | -65° to +175°C | | | |
| Current rating | 1.5 Amps | | | |
| Dielectric Withstanding Voltage (sea level) | 500 Vrms | EIA-364-20 | | |
| Insulation resistance | 5000 MΩ minimum | EIA-364-21 | | |
| Contact resistance, 25°C | 55 millivolt maximum | EIA-364-06, 1.0 A test current, #24 AWG wire | | |
| Shell-to-shell resistance | 2.0 millivolt maximum | EIA-364-83 | | |
| Shielding effectiveness | Frequency Attenuation dB 100 75 1000 50 3000 44 6000 38 10000 35 | EIA-364-66 | | |
| Ingress protection | IP67 rating | IEC-60529 | | |
| Vibration, sine | No discontinuity of greater than 1 microseconds, no cracking, breaking or loosening of parts, plug shall not become disengaged from receptacle. | EIA-364-28 Test Condition IV | | |
| Vibration, random | No discontinuity of greater than 1 microseconds, no cracking, breaking or loosening of parts, plug shall not become disengaged from receptacle. | 364-28 Test Condition V Letter I | | |
| Mechanical shock | No discontinuity of greater than 1 microsecond, no cracking, breaking or loosening of parts, plug shall not become disengaged from receptacle. | EIA-364-27 Condition D | | |
| Temperature cycling | No mechanical damage or loosening of parts. Following test, connector shall meet contact resistance, DWV, insulation resistance and shell-to-shell resistance requirements | EIA-364-32 Test Condition IV -65°C, +150°C. | | |
| Humidity | No deterioration which will adversely affect the connector. | EIA-364-31 | | |
| Durability | 2000 mating cycles | | | |

Application Note: Sand and Dust Exposure

Unmated SuperFly® connectors should not be exposed to sand, dust or debris, which can be entrapped in the small contact cavities. Debris entrapment can cause excessive contact wear and possible failure. Unmated connectors should be fitted with dust caps or protective covers.